

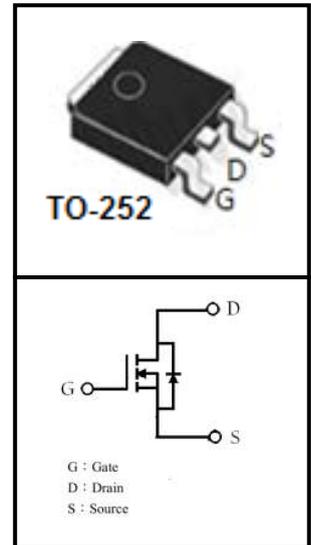
60V N-Channel Trench MOSFET

FEATURES

- Super Low Gate Charge
- 100% EAS Guaranteed
- RoHS compliant
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Hard switched and high frequency circuits



Device Marking and Package Information

Device	Package	Marking
CTD06N030	TO-252	CTD06N030

Absolute Maximum Ratings at $T_j = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage ($V_{GS} = 0\text{V}$)	V_{DSS}	60	V
Drain Current-Continuous($T_c = 25^\circ\text{C}$) (note1)	I_D	35	A
Drain Current-Continuous($T_c = 100^\circ\text{C}$) (note1)		22	A
Pulsed Drain Current (note2)	I_{DM}	46	A
Gate Source Voltage	V_{GSS}	± 20	V
Power Dissipation $T_c = 25^\circ\text{C}$ (note4)	P_D	41	W
Single Pulse Avalanche Energy (note3)	E_{AS}	26	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+175	$^\circ\text{C}$

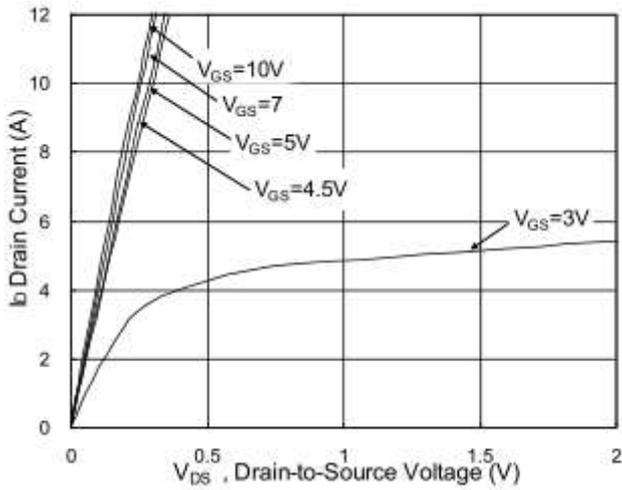
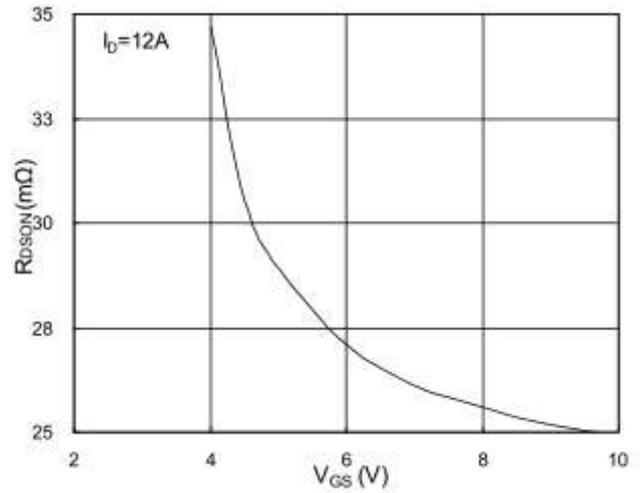
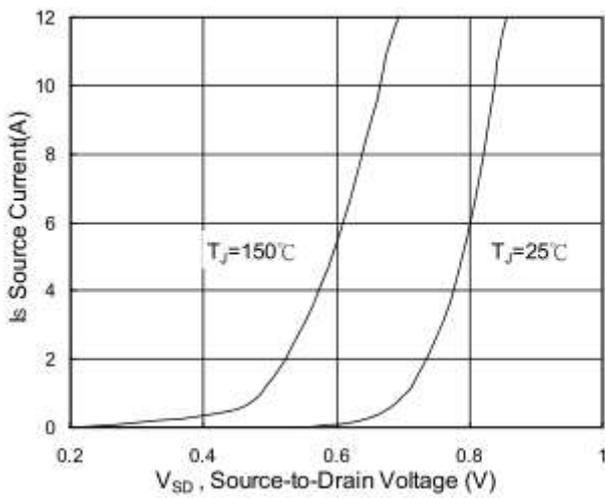
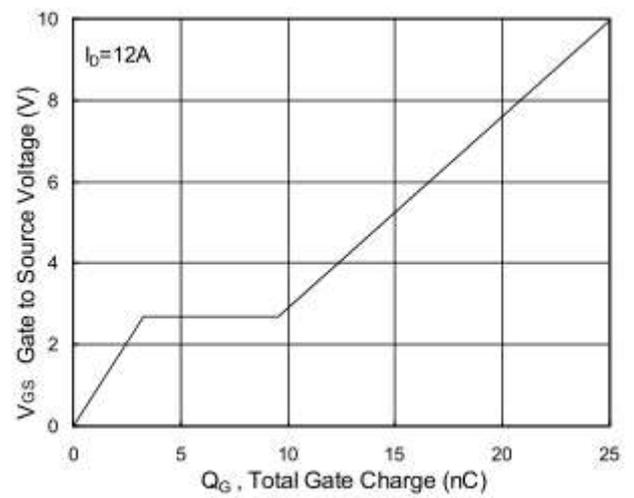
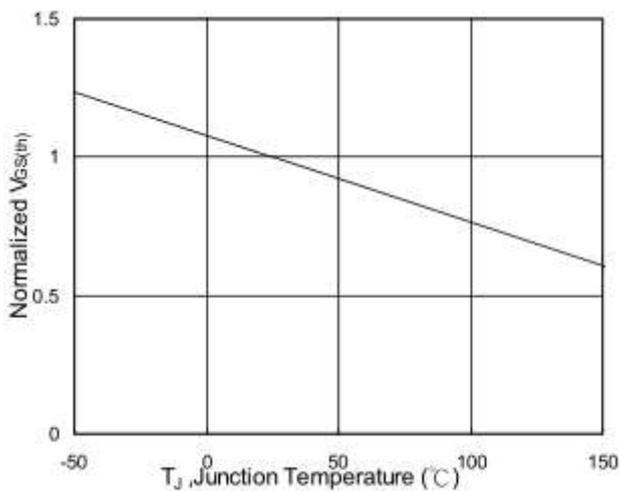
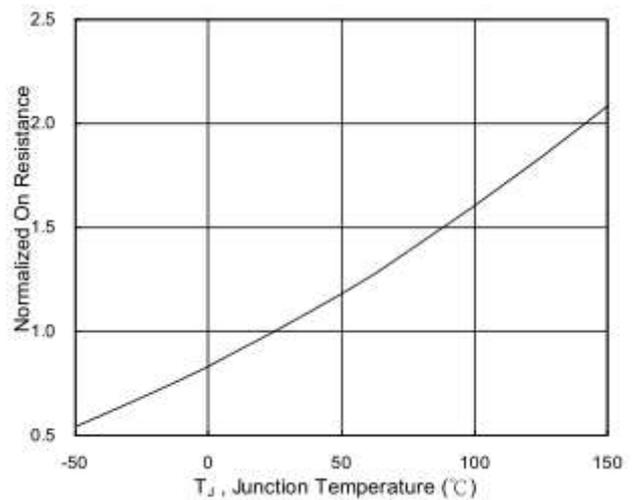
Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-Ambient (note1)	$R_{\theta JA}$	62	$^\circ\text{C/W}$
Thermal Resistance Junction-Case (note1)	$R_{\theta JC}$	3.6	$^\circ\text{C/W}$

Electrical Characteristics $T_j = 25^\circ\text{C}$ unless otherwise specified						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	60	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 48V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	μA
Zero Gate Voltage Drain Current		$V_{DS} = 48V, V_{GS} = 0V, T_J = 55^\circ\text{C}$	--	--	5	
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20V$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	--	2.5	V
Drain-Source On-Resistance (note2)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 15A$	--	25	30	$m\Omega$
		$V_{GS} = 4.5V, I_D = 10A$	--	30	38	$m\Omega$
Dynamic						
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = 15V,$ $f = 1.0MHz$	--	1378	--	pF
Output Capacitance	C_{oss}		--	86	--	
Reverse Transfer Capacitance	C_{rss}		--	64	--	
Total Gate Charge (4.5V)	Q_g	$V_{DS} = 48V, I_D = 15A,$ $V_{GS} = 10V$	--	12.6	--	nC
Gate-Source Charge	Q_{gs}		--	3.2	--	
Gate-Drain Charge	Q_{gd}		--	6.3	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 30V, I_D = 15A$ $V_{GS} = 10V, R_G = 3.3\Omega$	--	8	--	ns
Turn-on Rise Time	t_r		--	14.2	--	
Turn-off Delay Time	$t_{d(off)}$		--	24.4	--	
Turn-off Fall Time	t_f		--	4.6	--	
Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	35	A
Pulsed Diode Forward Current	I_{SM}		--	--	46	
Body Diode Voltage	V_{SD}	$I_{SD} = 5A, V_{GS} = 0V$	--	--	1.2	V

Notes

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating . The test condition is $V_{DD} = 25V, V_{GS} = 10V, L = 0.5mH$
4. The power dissipation is limited by 175 $^\circ\text{C}$ junction temperature
5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Fig.1 Typical Output Characteristics

Fig.2 On-Resistance vs. G-S Voltage

Fig.3 Forward Characteristics of Reverse Diode

Fig.4 Gate-Charge Characteristics

Fig.5 Normalized VGS(th) vs. TJ

Fig.6 Normalized RDSON vs. TJ

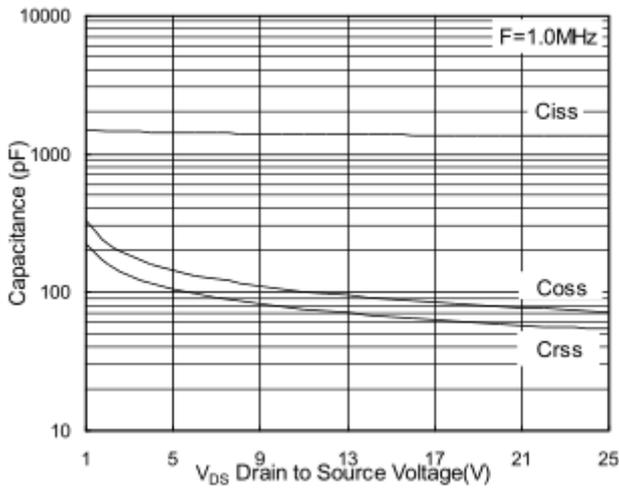
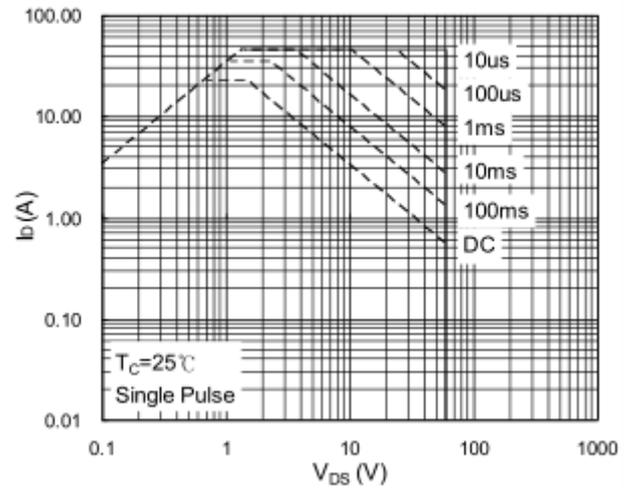
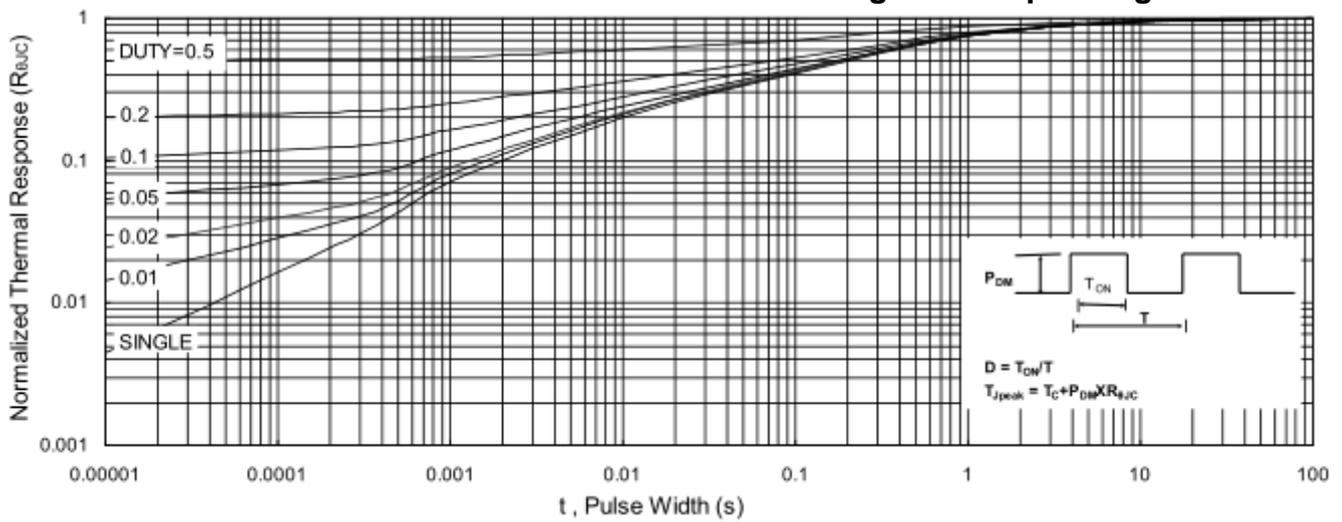
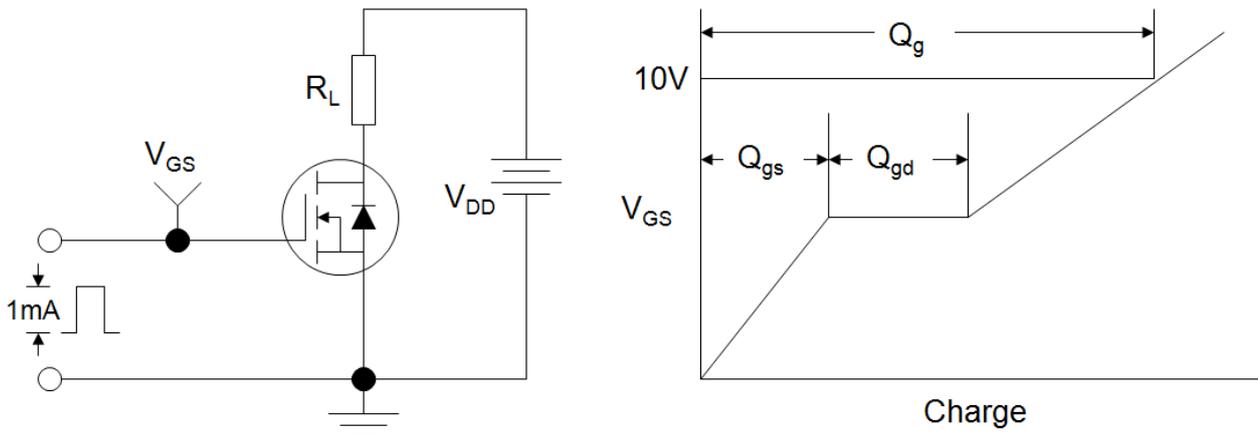
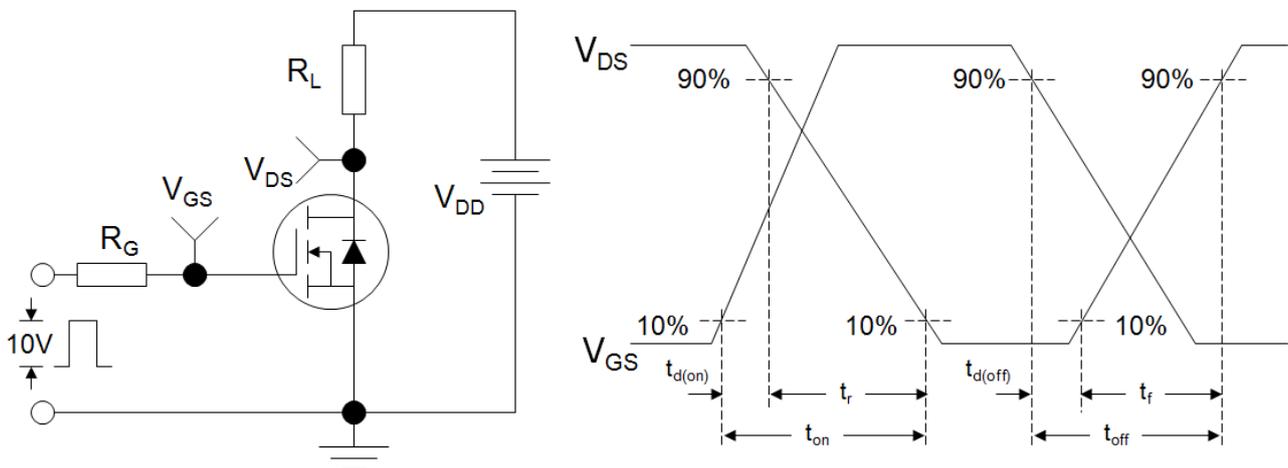
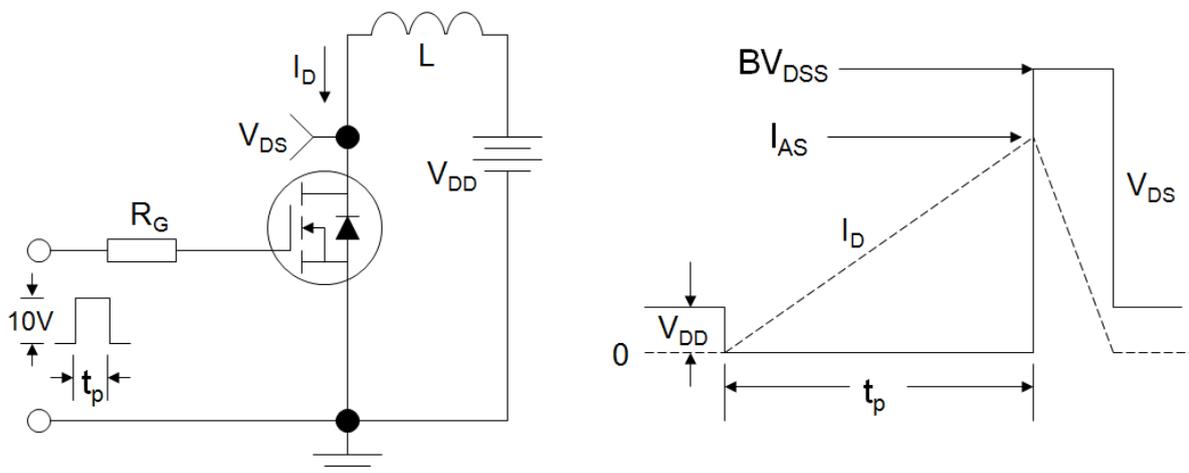
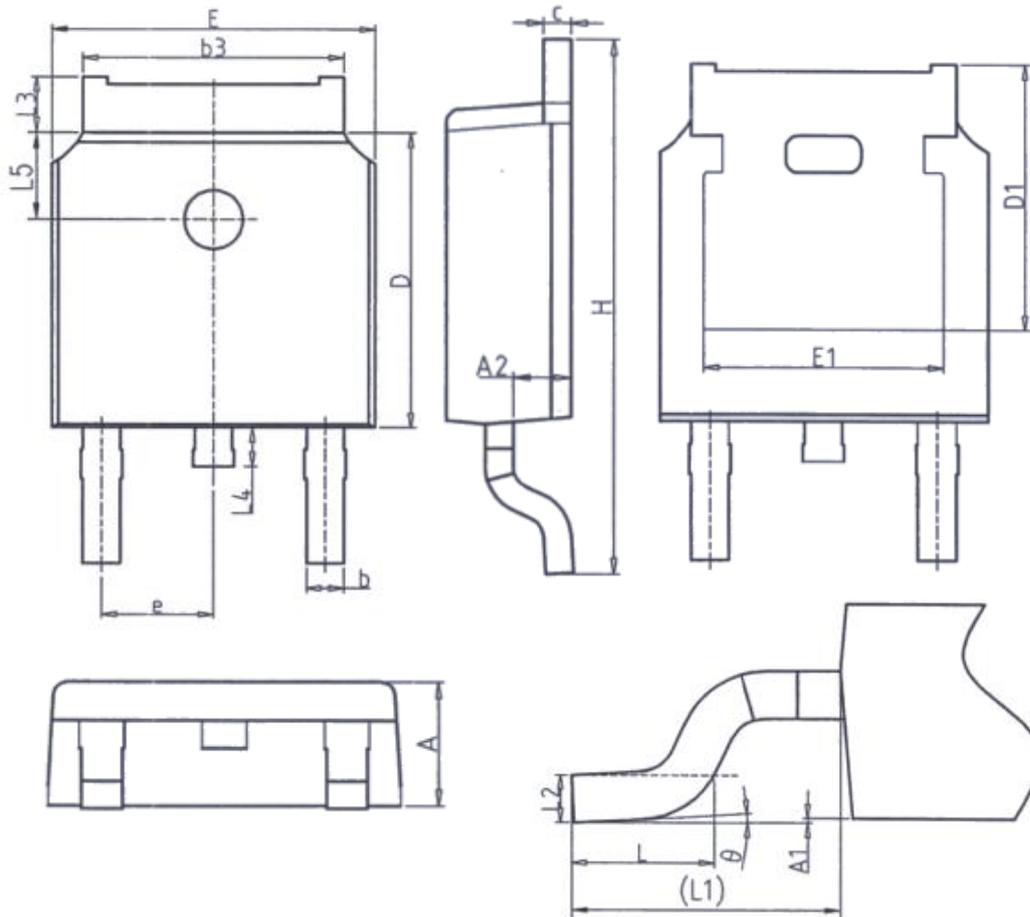
Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Figure A: Gate Charge Test Circuit and Waveform

Figure B: Resistive Switching Test Circuit and Waveform

Figure C: Unclamped Inductive Switching Test Circuit and Waveform


TO-252


Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A1	0.00	0.20
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22
D1	5.30REF	
E	6.40	6.80
E1	4.63	-

Unit: mm		
Symbol	Min.	Max.
e	2.286BSC	
H	9.40	10.50
L	1.38	1.75
L1	2.90REF	
L2	0.51BSC	
L3	0.88	1.28
L4	-	1.00
L5	1.65	1.95
θ	0°	8°

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